

# Thermal annealing effect on the band gap and dielectric functions of silicon nanocrystals embedded in SiO<sub>2</sub> matrix

Ding, Liang; Chen, Tupei; Liu, Yang; Ng, Chi Yung; Liu, Yu Chan; Fung, Stevenson Hon Yuen

2005

Ding, L., Chen, T., Liu, Y., Ng, C. Y., Liu, Y. C., & Fung, S. H. Y. (2005). Thermal annealing effect on the band gap and dielectric functions of silicon nanocrystals embedded in SiO<sub>2</sub> matrix. *Applied Physics Letters*, 87, 1-4.

<https://hdl.handle.net/10356/90792>

<https://doi.org/10.1063/1.2051807>

---

Applied Physics Letters © copyright 2005 American Institute of Physics. The journal's website is located at [http://apl.aip.org/applab/v87/i12/p121903\\_s1?isAuthorized=no](http://apl.aip.org/applab/v87/i12/p121903_s1?isAuthorized=no)

*Downloaded on 28 Feb 2024 18:41:04 SGT*

## Thermal annealing effect on the band gap and dielectric functions of silicon nanocrystals embedded in SiO<sub>2</sub> matrix

L. Ding, T. P. Chen,<sup>a)</sup> Y. Liu, and C. Y. Ng

*School of Electrical and Electronic Engineering, Nanyang Technological University, Singapore 639798*

Y. C. Liu

*Singapore Institute of Manufacturing Technology, Singapore 638075*

S. Fung

*Department of Physics, The University of Hong Kong, Hong Kong*

(Received 18 April 2005; accepted 28 July 2005; published online 12 September 2005)

The thermal annealing effect on band gap and dielectric functions of silicon nanocrystals (*nc*-Si) embedded in a SiO<sub>2</sub> matrix synthesized by Si ion implantation is investigated by spectroscopic ellipsometry. A large band-gap expansion of *nc*-Si relative to bulk crystalline silicon has been observed. The band gap of the *nc*-Si for the nonannealing condition (i.e., as implanted) is 1.78 eV while it is 1.72 eV for the annealing at 1000 °C for 100 min. The slight decrease in the band gap is attributed to the slight increase in the *nc*-Si size with annealing. The dielectric functions of *nc*-Si show a significant suppression, as compared to bulk crystalline silicon, due to the quantum size effect. Annealing results in a small change in the static dielectric constant, which can be explained in terms of the size effect also. © 2005 American Institute of Physics.

[DOI: [10.1063/1.2051807](https://doi.org/10.1063/1.2051807)]

There has been an increasing interest in semiconductor nanostructures after the initial work of Canham on visible luminescence from porous silicon,<sup>1</sup> because of their light-emission ability with high efficiency for potential applications in silicon-based optoelectronic devices. However, the practical application in optoelectronic devices of porous silicon is limited by its instability in light emission,<sup>2</sup> structural fragility, and incompatibility with conventional integrated circuit technology.<sup>3</sup> Therefore, silicon nanocrystals (*nc*-Si) are considered to be the preferable strategy for overcoming these challenges. Among the different techniques used to synthesize *nc*-Si, ion implantation of silicon into a dielectric matrix, preferably SiO<sub>2</sub> films, followed by high-temperature annealing, is deemed one of the most promising candidates for producing electrically and chemically stable silicon nanocrystals. This technique offers the advantage of being fully compatible with the complimentary metal-oxide-semiconductor (CMOS) process. In spite of the fact that efficient photoluminescence (PL) (Refs. 3–5) and electroluminescence (EL) (Refs. 6–8) in Si nanocrystals embedded in a SiO<sub>2</sub> matrix have been demonstrated, it remains necessary to accurately determine the dielectric functions of embedded *nc*-Si in order to perform reliable device modeling.

Many investigations on the optical properties of *nc*-Si have been carried out by luminescence studies<sup>3–8</sup> and theoretical calculations.<sup>9–13</sup> However, very few studies focused on the optical properties of *nc*-Si embedded in SiO<sub>2</sub> being prepared with Si ion implantation under different annealing conditions. In this work, we present a comprehensive optical study on *nc*-Si embedded in a SiO<sub>2</sub> matrix with spectroscopic ellipsometry (SE) in the photon-energy range of 1.1–5 eV. A multilayer optical model that takes into account the distribution of implanted Si ions is designed to analyze the SE response [i.e.,  $\tan(\psi)$  and  $\cos(\Delta)$  where  $\psi$  and  $\Delta$  are the ellipsometric angles]. The Maxwell-Garnett effective-

medium approximation (EMA) combined with the four-term Forouhi-Bloomer (FB) (Ref. 14) model has been used to determine the dielectric functions of *nc*-Si embedded in the SiO<sub>2</sub> matrix synthesized with different annealing times. A large optical band-gap expansion and a strong dielectric suppression for *nc*-Si have been observed from the analysis based on the FB model. The effects of postimplantation thermal annealing on both the band gap and the dielectric functions of the *nc*-Si have been investigated.

550-nm-thick SiO<sub>2</sub> thin films were grown on *p*-type silicon substrates with (100) orientation by thermal oxidation in dry oxygen at 950 °C. A dose of  $1 \times 17$  atoms/cm<sup>2</sup> Si ions were then implanted into SiO<sub>2</sub> films at the energy of 100 keV. Postimplantation thermal annealing was carried out in nitrogen ambient at various temperatures for different annealing times. For simplicity, only the results of annealing at 1000 °C for various annealing durations ranging from 0 to 100 min (0, 20, 30, 40, 60, 80, and 100 min) are presented here. The average size of *nc*-Si was determined from the broadening of the Bragg peak in x-ray diffraction (XRD) measurements.<sup>15</sup> The *nc*-Si size obtained was from ~3.3 nm for the as-implanted sample to ~4.5 nm for the samples annealed at 1000 °C for different durations. The *nc*-Si sizes for various annealing durations obtained from the XRD measurements are shown in Table I. A very small increase in the *nc*-Si size with annealing is observed. This slow evolution in the size is due to the very low diffusion coefficient of Si in the SiO<sub>2</sub> film, being consistent with the results reported in Ref. 16. The SE measurements were carried out in the wavelength range of 250 and 1100 nm with a step of 5 nm, and the incidence angle was set to 75°.

The profile of excess Si in the SiO<sub>2</sub> thin films was measured with secondary-ion mass spectroscopy (SIMS). The implanted Si distributes from the surface to the depth of ~250 nm, and the subsequent annealing does not change the profile significantly because of the extremely low diffusion coefficient of Si in SiO<sub>2</sub> films. There is almost no *nc*-Si beyond the depth of 250 nm in the SiO<sub>2</sub> film. In order to

<sup>a)</sup>Electronic mail: [echentp@ntu.edu.sg](mailto:echentp@ntu.edu.sg)

TABLE I. Size, band gap, and static dielectric constant of *nc*-Si annealed for different durations.  $E_g^{\text{exp}}$  and  $\epsilon_{\text{static}}^{\text{exp}}$  are the band gap and the static dielectric constant of *nc*-Si obtained from the spectral fittings based on the four-term FB model, respectively.  $E_g^{\text{cal}}$  is the *nc*-Si band gap obtained from the calculation with Eq. (1), while  $\epsilon_{\text{static}}^{\text{cal}}$  is the *nc*-Si static dielectric constant obtained from the calculation with Eq. (2).

Annealing time (min)	Size (nm)	$E_g^{\text{cal}}$ (eV)	$E_g^{\text{exp}}$ (eV)	$\epsilon_{\text{static}}^{\text{cal}}$	$\epsilon_{\text{static}}^{\text{exp}}$
0	3.3±0.4	2.03±0.15	1.78	8.98±0.34	8.82
20	4.6±0.2	1.73±0.03	1.74	9.72±0.08	9.67
30	4.2±0.2	1.79±0.05	1.74	9.54±0.10	9.52
40	4.5±0.2	1.74±0.04	1.74	9.68±0.09	9.73
60	4.3±0.2	1.78±0.04	1.75	9.59±0.10	9.73
80	4.5±0.2	1.74±0.04	1.74	9.68±0.10	9.61
100	4.5±0.2	1.74±0.04	1.72	9.68±0.10	9.73

extract the dielectric functions of *nc*-Si embedded in SiO<sub>2</sub>, the multilayer optical model shown in Fig. 1 was used to analyze the SE data. As can be seen in Fig. 1, the layer containing *nc*-Si, whose thickness  $d_1$  is 250 nm, is divided into 25 sublayers with equal thickness  $d_0=10$  nm. Each sublayer can be optically schematized as an effective medium represented by the Maxwell-Garnett EMA. The Maxwell-Garnett EMA is characterized by the volume fraction of *nc*-Si which can be obtained from the SIMS measurement, the known dielectric functions of SiO<sub>2</sub>, and the *nc*-Si dielectric functions that are to be determined. Therefore, the Maxwell-Garnett EMA is used to extract the *nc*-Si dielectric functions from the SE spectral fitting. For the spectral fitting an optical dispersion model for the *nc*-Si is required. We have found that the four-term FB model<sup>14</sup> is the suitable one that can yield a successful fitting. As such, the Maxwell-Garnett EMA based on the four-term FB model is used in the SE spectral fitting. In the spectral fitting, the optimization is carried out by freely varying the 14 parameters,<sup>14</sup> which include the parameters  $A_i, B_i, C_i$  ( $i=1, 2, 3,$  and  $4$ ) for the four terms, the refractive index  $n(\infty)$  when photon energy  $E \rightarrow \infty$ , and the band gap  $E_g$  to minimize the mean-square error (MSE) (Ref. 17). As a typical example, the spectral fitting of

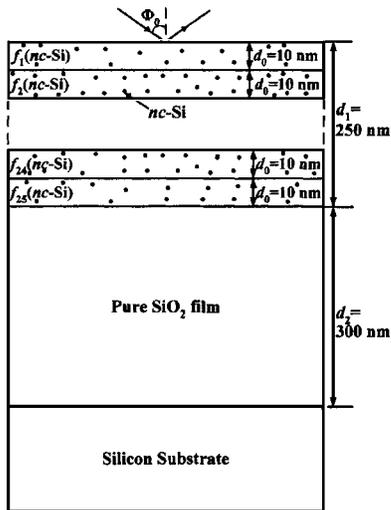


FIG. 1. Multilayer model used in the SE analysis. The thickness of the SiO<sub>2</sub> thin film grown on the silicon substrate is 550 nm, the *nc*-Si distributes from the surface to the depth ( $d_1$ ) of 250 nm in the SiO<sub>2</sub> film, and thus the thickness ( $d_2$ ) of the pure SiO<sub>2</sub> layer is 300 nm. The *nc*-Si-distributed layer with the thickness  $d_1$  is divided into 25 sublayers with equal thickness  $d_0 = 10$  nm. The volume fraction of the *nc*-Si in each sublayer is  $f_i(nc\text{-Si})$  ( $i = 1, 2, \dots, 25$ ). The diagram is not drawn to scale.

the sample annealed for 30 min, which has a MSE of 0.012, is shown in Fig. 2. A very small MSE (0.007–0.019) is also obtained for other samples. The excellent spectral fittings of all samples indicate that the four-term FB dispersion relation can accurately describe the spectral dependence of the *nc*-Si dielectric functions.

The *nc*-Si band gap ( $E_g$ ) obtained from the spectral fittings for various annealing durations is given in Table I. The *nc*-Si shows a large expansion in the band gap as compared to the bulk crystalline silicon, i.e., a band-gap expansion of  $\sim 0.6$  eV is observed. The *nc*-Si band gap obtained in this work is in very good agreement with the first-principles calculation of the optical gap of silicon nanocrystals based on quantum confinement.<sup>11</sup> A fit to the calculation shown in Fig. 3 of Ref. 11 yields

$$E_g(D) = E_{g0} + C/D^n, \quad (1)$$

where  $D$  is the nanocrystal size in nm,  $E_g(D)$  is the band gap in eV of the nanocrystal,  $E_{g0}=1.12$  eV is the band gap of bulk crystalline Si,  $C=3.9$ , and  $n=1.22$ . For comparison, the band gap of *nc*-Si calculated with Eq. (1) is presented in Table I. The very good agreement shown in Table I strongly suggests that the band-gap expansion is a result of quantum size effect.

As examples, the dielectric functions of *nc*-Si obtained after 0 (nonannealing), 30, and 80 min of annealing are shown in Fig. 3. The dielectric functions of bulk crystalline silicon are also included in the figure for comparison. Obviously, the *nc*-Si exhibits a significant reduction in the dielectric functions with respect to bulk crystalline silicon. It is observed that the dielectric-function spectra of the *nc*-Si of

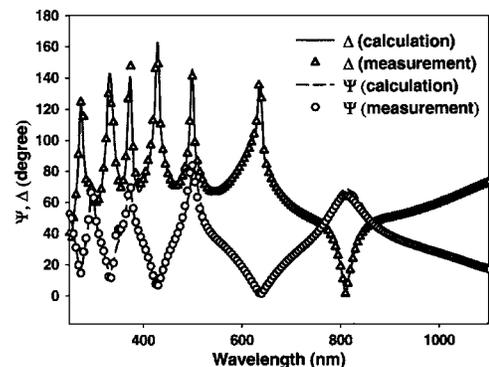


FIG. 2. Typical spectral fitting of the ellipsometric angles  $\psi$  and  $\Delta$ . The sample is annealed at 1000 °C for 30 min.

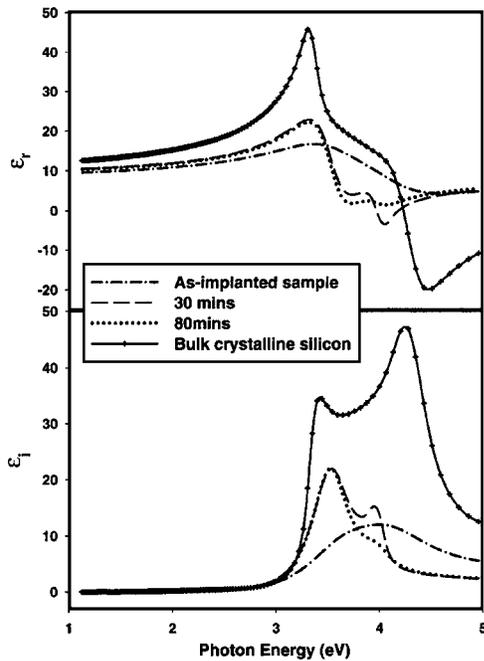


FIG. 3. Real ( $\epsilon_r$ ) and imaginary ( $\epsilon_i$ ) parts of the complex dielectric functions of both the *nc*-Si annealed for 0, 30, and 80 min and the bulk crystalline silicon as functions of photon energy.

different annealing durations, except the nonannealing sample, are very similar. This is not surprising, and it can be explained in terms of quantum size effect on the dielectric functions.<sup>9,15</sup> As shown in Table I, except for the nonannealing sample which shows a *nc*-Si size of  $\sim 3.3$  nm, all other samples with different annealing durations have almost the same *nc*-Si size ( $\sim 4.5$  nm). In general, the dielectric functions of bulk crystalline silicon show main peaks at the transition energies  $E_1$  ( $\sim 3.4$  eV) and  $E_2$  ( $\sim 4.3$  eV) as its critical points. As for the case of *nc*-Si formed after high-temperature annealing, the dielectric functions show a slight blueshift in the main transition energy  $E_1$  ( $\sim 3.6$  eV) position, and a slight redshift in the  $E_2$  ( $\sim 4.0$  eV) position. However, in the case of the as-implanted (i.e., nonannealing) sample, the dielectric functions of *nc*-Si show only a single peak in the experimental photon-energy range, possibly because of larger broadenings of  $E_1$  and  $E_2$  band gaps due to a large change of surface area to volume ratio when the size of *nc*-Si is close to 3 nm.

On the other hand, the static dielectric constant ( $\epsilon_{\text{static}}^{\text{exp}}$ ) of *nc*-Si is obtained by setting the photon energy to zero in the FB model, and the result is given in Table I. Thanks to the extensive studies on the nanostructured silicon, the fact that the suppression of the dielectric constant becomes significant when the nanocrystal size approaches the nanometric range is, nowadays, unquestionable. However, the origin of the reduction in dielectric constant with decreasing size is still under debate. Among the different mechanisms proposed for dielectric suppression of nanoscale materials, most are related to: (i) opening of the band gap, which lowers the polarizability, and (ii) the breaking of polarizable bonds at the surface. Nevertheless, in the present study, the static dielectric constant of *nc*-Si is found to be significantly suppressed as compared to that of bulk crystalline silicon, as shown in Table I. Taking the screening effect by the medium into account, the static dielectric constant of the *nc*-Si as a function

of the nanocrystal size could be expressed as follows:<sup>9</sup>

$$\epsilon_{\text{static}}(D) = 1 + \frac{\epsilon_{\text{static}}(\infty) - 1}{1 + \left(\frac{1.38}{D}\right)^{1.37}}, \quad (2)$$

where  $\epsilon_{\text{static}}(\infty)$  is the static dielectric constant of bulk crystalline silicon and  $D$  is the diameter of *nc*-Si with the unit of nm. The static dielectric constant calculated with Eq. (2) is also presented in Table I. It can be seen in the table that there is a good agreement between the values ( $\epsilon_{\text{static}}^{\text{cal}}$ ) calculated from Eq. (2) and the extracted values ( $\epsilon_{\text{static}}^{\text{exp}}$ ) from the SE analysis.

In conclusion, we have investigated the thermal annealing effect on the dielectric functions and band gap of silicon nanocrystals embedded in a  $\text{SiO}_2$  matrix by spectroscopic ellipsometry. In the SE analysis, a multilayer optical model that takes into account the *nc*-Si distributions in the  $\text{SiO}_2$  film, the Maxwell-Garnett effective medium approximation, and the four-term Forouhi-Bloomer optical dispersion relation are used. The dielectric functions of *nc*-Si for different annealing durations show a significant suppression as compared to bulk crystalline silicon, which is attributed to the quantum size effect. The *nc*-Si of the as-implanted (i.e., nonannealing) sample presents only one peak in the dielectric spectra, while the annealed ones have two critical points in the range of 1–5 eV. The *nc*-Si for various annealing durations shows a large band-gap expansion of  $\sim 0.6$  eV, which is in good agreement with the theoretical calculation based on quantum confinement. The band gap of the *nc*-Si for the nonannealing condition (i.e., as implanted) is 1.78 eV while it is 1.72 eV for the annealing at 1000 °C for 100 min. The slight decrease in the band gap is attributed to the slight increase in the *nc*-Si size with annealing.

This work has been financially supported by the Ministry of Education Singapore under Project No. ARC 1/04.

- <sup>1</sup>L. T. Canham, Appl. Phys. Lett. **57**, 1046 (1990).
- <sup>2</sup>M. A. Tichler, R. T. Collins, J. H. Stathis, and J. C. Tsang, Appl. Phys. Lett. **60**, 639 (1992).
- <sup>3</sup>P. Mutti, G. Ghisloti, S. Bertoni, L. Bonoldi, G. F. Cerofolini, L. Meda, E. Grilli, and M. Guzzi, Appl. Phys. Lett. **66**, 851 (1994).
- <sup>4</sup>K. S. Zhuravlev, A. M. Gilinsky, and A. Yu. Kobitsky, Appl. Phys. Lett. **73**, 2962 (1998).
- <sup>5</sup>X. L. Wu, S. J. Xiong, G. G. Siu, G. S. Huang, Y. F. Mei, Z. Y. Zhang, S. S. Deng, and C. Tan, Phys. Rev. Lett. **91**, 157402 (2003).
- <sup>6</sup>P. J. Walters, G. I. Bourianoff, and H. A. Atwater, Nat. Mater. **4**, 143 (2005).
- <sup>7</sup>J. Linnros, Nat. Mater. **4**, 117 (2005).
- <sup>8</sup>A. Irrera, D. Pacifici, M. Miritello, G. Franzo, F. Priolo, F. Iacona, D. Sanfilippo, G. D. Stefano, and P. G. Fallica, Physica E (Amsterdam) **16**, 395 (2003).
- <sup>9</sup>L. W. Wang and A. Zunger, Phys. Rev. Lett. **73**, 1039 (1994).
- <sup>10</sup>C. Delerue, G. Allan, and M. Lannoo, Phys. Rev. B **48**, 11024 (1993).
- <sup>11</sup>S. Ogut, J. R. Chelikowsky, and S. G. Louie, Phys. Rev. Lett. **79**, 1770 (1997).
- <sup>12</sup>I. Vasiliev, S. Ogut, and J. R. Chelikowsky, Phys. Rev. Lett. **86**, 1813 (2001).
- <sup>13</sup>H.-Ch. Weissker, J. Furthmüller and F. Bechstedt, Phys. Rev. B **65**, 155327 (2002).
- <sup>14</sup>A. R. Forouhi and I. Bloomer, Phys. Rev. B **38**, 1865 (1988).
- <sup>15</sup>T. P. Chen, Y. Liu, M. S. Tse, O. K. Tan, P. F. Ho, and K. Y. Liu, Phys. Rev. B **68**, 153301 (2003).
- <sup>16</sup>G. Garrido, M. Lopez, O. Gonzalez, A. P. Rodriguez, J. R. Morante, and C. Bonafon, Appl. Phys. Lett. **77**, 3143 (2000).
- <sup>17</sup>Guide to Using WVASE32TM (WexTech Systems, Inc., Madison Avenue, New York).

Applied Physics Letters is copyrighted by the American Institute of Physics (AIP).  
Redistribution of journal material is subject to the AIP online journal license and/or AIP  
copyright. For more information, see <http://ojps.aip.org/aplo/aplcr.jsp>